

# Powerful Sensing Solutions for a Better Life

## Ultra Low Cost ACCELEROMETER

Chip Scale Packaged Fully Integrated Thermal Accelerometer MXC622xXC

MXC622xXC: Fully Integrated Thermal Accelerometer



### Features

- Fully Integrated Thermal Accelerometer
- X/Y Axis, 8 bit, Acceleration A/D Output (± 2g)
- Chip Scale Package (1.17x1.70x1.0mm)
- 4-position Orientation Detection
- Shake Detection with Interrupt
- · Programmable Shake Threshold
- Shake Direction Detection
- I2C Interface
- Power Down Mode
- Shock Survival Greater than 50,000 g
- Operating Supply Voltage from 2.5V to 5.5V
- Produces no Mechanical Sounds ("click")

## Applications

#### ◆ Consumer:

Cell Phones

Digital Still Cameras (DSC)

Digital Video Cameras (DVC)

LCD TV

Toys

MP3, MP4 Players

#### · Household Safety:

Fan Heaters

Halogen Lamps

Iron

Cooling Fans

### General Description

The MEMSIC Digital Thermal Orientation Sensor is the world's first fully-integrated orientation sensor also with chip scale package, it is the world smallest accelerometer. Its operation is based on our patented MEMS-thermal technology and is built using a standard 0.18um CMOS process. This sensor contains no moving parts (such as a ball) and thus eliminates field-reliability and repeatability issues associated with competitive products. It also eliminates the "click" sounds typically heard in ball based orientation sensors. Shock survival is greater than 50,000g. This sensor detects four orientation positions, shake and shake direction. In addition, it provides X/Y axis acceleration signals with very low 0g offset. An I<sup>2</sup>C interface is used to communicate with this device and an interrupt pin (INT) is provided for shake and orientation. The device also has a power down enabled through the I<sup>2</sup>C interface.

## Functional Block Diagram

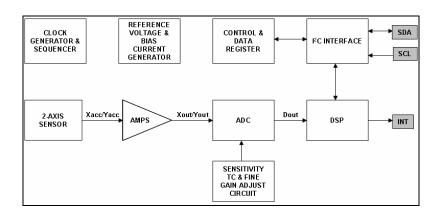


Figure 1

This sensor is packaged in a Chip Scale Package (1.17x1.70x1.0mm), the product is RoHS compatible and operates over  $-20^{\circ}70^{\circ}$ C temperature range.

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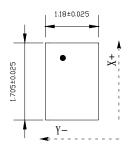


Figure 2

Top View (small circle indicate pin 1)

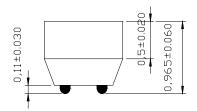


Figure 3 Side View

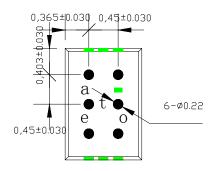


Figure 4 Bottom View

### Pin Description: CSP Package

| Pin | Name                 | Description   |  |  |
|-----|----------------------|---|--|--|
| 1   | I <sup>2</sup> C SCL | This pin is the serial clock line for the $\mbox{I}^2\mbox{C}$ interface on the MXC622XXC. Since the MXC622XXC only operates      |  |  |
|     |                      | as a slave device, this pin is always an input.   |  |  |
| 2   | NC                   | During normal operation, this pin should be left floating.  |  |  |
| 3   | GND                  | This is the ground pin for the MXC622xXC.   |  |  |
| 4   | INT                  | This pin is the MXC622xXC interrupt output. The logic level on this pin reflects the state of the INT bit in the                  |  |  |
|     |                      | STATUS register. INT is set when the orientation differs from the last orientation read by the processor, or a                    |  |  |
|     |                      | shake event is detected. INT is cleared upon the read of the STATUS register.   |  |  |
| 5   | I <sup>2</sup> C SDA | This pin is the serial data line for the I <sup>2</sup> C interface on the MXC622xXC. It is an I/O pin that functions as an input |  |  |
|     |                      | during a write to the MXC622xXC, and an output during a read from the MXC622xXC.  |  |  |
| 6   | VDD                  | This is the power supply input for the MXC622xXC. The DC voltage should be between 2.5 and 5.5 volts.                             |  |  |

### **Absolute Maximum Ratings\***

| Supply Voltage (V <sub>DD</sub> ) | 0.5 V to +7.0V  |
|-----------------------------------|-----------------|
| Storage Temperature               | 40°C to +150°C  |
| Acceleration                      | 50,000 <i>g</i> |

\*Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; the functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability

## Electrical Specifications<sup>1</sup>

| Parameter (Units)                | Conditions         | Minimum | Typical | Maximum |
|----------------------------------|--------------------|---------|---------|---------|
| Operating Voltage Range (V)      |                    | 2. 5    |         | 5. 5    |
| Supply Current (mA)              | In power-up mode   |         | 1.0     |         |
| Supply Current (mA)              | In power-down mode |         | 0.0004  | 0. 001  |
| Turn-On Time (ms) <sup>2</sup>   |                    |         | 300     | 500     |
| Turn-off Time (us)               |                    |         |         | 1       |
| Operating Temperature Range (°C) |                    | -20     |         | +70     |
| VDD Rise Time (ms) <sup>3</sup>  |                    |         |         | 10      |

Notes: 1 All specifications are at 3V and room temperature unless otherwise noted. 2 Time to obtain valid data after existing power-down mode. 3 Maximum allowable power supply rise time from 0.25V to 2.5V (minimum). Slower VDD rise time may cause erroneous data retrieval from OTP memory at power-up.

## Sensor Characteristics<sup>1</sup>

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| Parameter (Units)                      | Conditions                        | Minimum | Typical | Maximum |
|--|-----------------------------------|---------|---------|---------|
| Measurement Range (g)                  | X/Y Axis                          |         |         | ± 2.0   |
| Alignment Error (°)                    | X/Y Axis                          |         | ± 1.0   | ± 2.0   |
| Sensitivity Error (%)                  | X/Y Axis                          |         | ± 5.0   |         |
| Sensitivity (LSB/g)                    | X/Y Axis                          |         | 64      |         |
| Sensitivity Drift Over Temperature (%) | Delta from 25 °C (-20 °C - 70 °C) |         | ± 15    |         |
| Zero g Offset Bias Level (mg)          | X/Y Axis (25 °C)                  |         | ± 50    |         |
| Zero g Offset Temperature coefficient  | X/Y Axis (-20 °C - 70 °C)         |         | 0.6     |         |
| (mg/℃)                                 |                                   |         |         |         |
| 3dB Signal Bandwidth (Hz)              |                                   |         | 10      |         |

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Notes: 1 All specifications are at 3V and room temperature unless otherwise noted.

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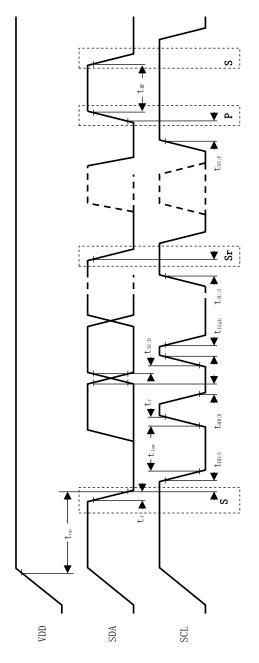


Figure 5

## Digital Parameters

| Symbo1            | Parameter (Units)                   | Minimum | Typical | Maximum |
|-------------------|-------------------------------------|---------|---------|---------|
| $V_{\mathrm{IH}}$ | High Level Input Voltage (Volts)    | 0.8*VDD |         |         |
| V <sub>IL</sub>   | Low Level Input Voltage (Volts)     |         |         | 0.2*VDD |
| V <sub>ims</sub>  | Hysteresis of Schmitt Trigger Input | 0. 1    |         |         |
|                   | (Volts)                             |         |         |         |
| $I_{\text{IL}}$   | Input Leakage, All Inputs (uA)      | -10     |         | 10      |
| V <sub>oL</sub>   | Low Level Output Voltage (Volts)    |         |         | 0. 4    |

## Digital Switching Characteristics

| Symbol                        | Parameter (Units)                         | Minimum | Typical | Maximum |
|-------------------------------|---|---------|---------|---------|
| t <sub>op</sub>               | Operating Valid Time (us)'                |         |         | 20      |
| $\mathbf{f}_{\text{SCL}}$     | SCK Clock Frequency (kHz)                 | 0       |         | 400     |
| $t_r$                         | Rise Time (us)                            |         |         | 0. 3    |
| t <sub>f</sub>                | Fall Time (us)                            |         |         | 0.3     |
| $t_{low}$                     | SCL Low Time (us)                         | 1.3     |         |         |
| $t_{\rm high}$                | SCL High Time (us)                        | 0.6     |         |         |
| t <sub>HD:D</sub>             | Data Hold Time (us)                       | 0       |         | 0. 9    |
| $t_{\scriptscriptstyle SU;D}$ | Data Set-Up Time (us)                     | 0.1     |         |         |
| $t_{\scriptscriptstyle SU;S}$ | Start Set-Up Time (us)                    | 0.6     |         |         |
| t <sub>HD:S</sub>             | Start Hold Time (us)                      | 0.6     |         |         |
| $t_{\scriptscriptstyle SU;P}$ | Stop Set-Up Time (us)                     | 0.6     |         |         |
| t <sub>BF</sub>               | Bus Free Time Between Start and Stop (us) | 1.3     | 11.1.1  |         |

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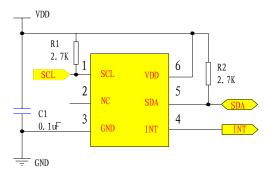
Notes: 1 Time to operate MXC622XXC through I^C interface after power being supplied to VDD.

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## Circuit Schematics

Life



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Figure 6

### Note:

- R1 and R2 are pull-up resistors, the value can be determined by customer according to the requirement of the host device.
- INT does not need any pull-up/pull-down resistor
- $\bullet\,$  If INT is not used, just keep it disconnected, don't pull up or pull down Leave NC pin as no connection.

## Landing Pattern

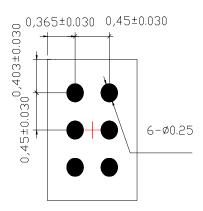
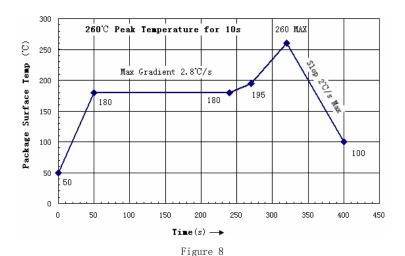


Figure 7

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### Reflow Profile



Reflow Profile

#### Note:

- Reflow is limited by 2 times
- The second reflow cycle should be applied after device has cooled down to 25°C (room temperature)
- This is the reflow profile for Pb free process
- The peak temperature on the sensor surface should be limited under 260°C for 10 seconds.
- Solder paste's recommendation can be followed for the best SMT quality.

## Manual Soldering

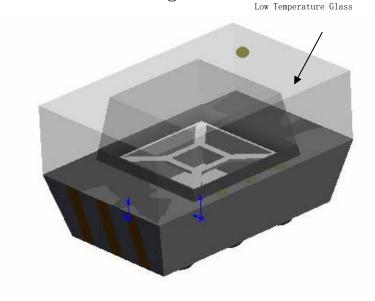


Figure 9
Chip Scale Package

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### Note:

- When soldering manually or repairing via soldering iron for a Chip Scale packaged device, the time should be limited to less than 10 seconds and the temperature should not exceed 275°C. If a heat gun is used, the time should be limited to less than 10 seconds and the temperature should not exceed 270°C
- Please avoid to bend the PCB after the sensor assembly

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State Bits OR

[1,0]

01

00

11

10



Orientation (Bottom View)

### Orientation/Shake Characteristics

#### Output state response to orientation

If the sensor is rotated past the 45 degree threshold, the orientation bits will change only if the sensor stays in the same state for a defined period of time. If the sensor crosses back before this time period, the orientation bits remain unchanged. This is to prevent dithering of the orientation state. Four user programmable hysteresis time periods are available: 160, 320, 640 and 1280ms.

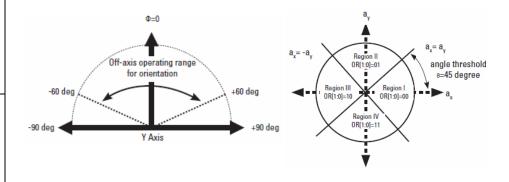


Figure 11 Figure 12

MXC622xXC is guaranteed to detect orientation changes with up to 60 degrees of off-axis tilt

### Shake Detection

Shake and shake direction are orthogonal to screen orientation. An interrupt pin (INT) is set high and must be cleared by the MCU via the  $I^2C$  interface. Four user programmable thresholds are available: 0.5g, 1g, 1.5g and 2g.

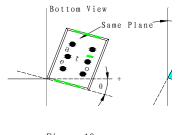


Figure 10



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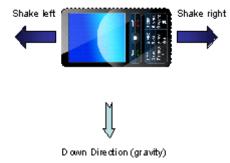


Figure 13

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## I<sup>2</sup>C Interface

A slave mode I<sup>2</sup>C interface, capable of operating in standard or fast mode, is implemented on the MXC622xXC. The interface uses a serial data line (SDA) and a serial clock line (SCL) to achieve bi-directional communication between master and slave devices. A master (typically a microprocessor) initiates all data transfers to and from the device, and generates the SCL clock that synchronizes the data transfer. The SDA pin on the MXC622xXC operates both as an input and an open drain output. Since the MXC622xXC only operates as a slave device, the SCL pin is always an input. There are external pull-up resistors on the I<sup>2</sup>C bus lines. Devices that drive the I<sup>2</sup>C bus lines do so through open-drain n-channel driver transistors, creating a wired NOR type arrangement.

Data on SDA is only allowed to change when SCL is low. A high to low transition on SDA when SCL is high is indicative of a START condition, whereas a low to high transition on SDA when SCL is high is indicative of a STOP condition. When the interface is not busy, both SCL and SDA are high. A data transmission is initiated by the master pulling SDA low while SCL is high, generating a START condition. The data transmission occurs serially in 8 bit bytes, with the MSB transmitted first. During each byte of transmitted data, the master will generate 9 clock pulses. The first 8 clock pulses are used to clock the data, the 9th clock pulse is for the acknowledge bit. After the 8 bits of data are clocked in, the transmitting device releases SDA, and the receiving device pulls it down so that it is stable low during the entire 9th clock pulse. By doing this, the receiving device "acknowledges" that it has received the transmitted byte. If the slave receiver does not generate an acknowledge, then the master device can generate a STOP condition and abort the transfer. If the master is the receiver in a data transfer, then it must signal the end of data to the slave by not generating an acknowledge on the last byte that was clocked out of the slave. The slave must release SDA to allow the master to generate a STOP or repeated START condition.

The master initiates a data transfer by generating a START condition. After a data transmission is complete, the master may terminate the data transfer by generating a STOP condition. The bus is considered to be free again a certain time after the STOP condition. Alternatively, the master can keep the bus busy by generating a repeated START condition instead of a STOP condition. This repeated START condition is functionally identical to a START condition that follows a STOP. Each device that sits on the  $I^2C$  bus has a unique 7 bit address.

The first byte transmitted by the master following a START is used to address the slave device.

The first 7 bits contain the address of the slave device, and the 8th bit is the R/W\* bit (read = 1, write = 0; the asterisk indicates active low, and is used instead of a bar). If the transmitted address matches up to that of the MXC622xXC, then the MXC622xXC will acknowledge receipt of the address, and prepare to receive or send data.

If the master is writing to the MXC622xXC, then the next byte that the MXC622xXC receives, following the address byte, is loaded into the address counter internal to the MXC622xXC. The contents of the address counter indicate which register on the MXC622xXC is being accessed. If the master now wants to write data to the MXC622xXC, it just continues to send 8-bit bytes. Each byte of data is latched into the register on the MXC622xXC that the address counter points to. The address counter is incremented after the transmission of each byte.

If the master wants to read data from the MXC622xXC, it first needs to write the address of the register it wants to begin reading data from to the MXC622xXC address counter. It does this by generating a START, followed by the address byte containing the MXC622xXC address, with R/W\* = 0. The next transmitted byte is then loaded into the MXC622xXC address counter. Then, the master repeats the START condition and re-transmits the MXC622xXC address, but this time with the R/W\* bit set to 1. During the next transmission period, a byte of data from the MXC622xXC register that is addressed by the contents of the address counter will be transmitted from the MXC622xXC to the master.

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As in the case of the master writing to the MXC622xXC, the contents of the address counter will be incremented after the transmission of each byte. The protocol for multiple byte reads and writes between a master and a slave device is depicted in Figure 14.

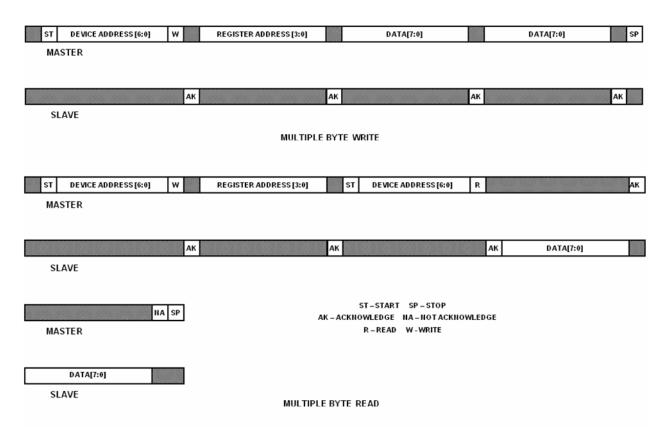


Figure 14

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The  $I^2C$  address for MXC622xXC is set as:

| Product   | Address |
|-----------|---------|
| MXC6220XC | 20h     |
| MXC6221XC | 22h     |
| MXC6222XC | 24h     |
| MXC6223XC | 26h     |
| MXC6224XC | 28h     |
| MxC6225XC | 2Ah     |
| MXC6226XC | 2Ch     |
| MXC6227XC | 2Eh     |

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## User Register Summary

| Address | Name      | Definition   | Access | Default  |
|---------|-----------|--|--------|----------|
| \$00    | XOUT      | 8-bit x-axis acceleration output                       | read   | 00000000 |
| \$01    | YOUT      | 8-bit y-axis acceleration output                       | read   | 00000000 |
| \$02    | STATUS    | orientation and shake status                           | read   | 00000000 |
| \$04    | DETECTION | Power down, orientation and shake detection parameters | write  | 00000000 |
| \$08    | CHIP_ID   | Chip ID of MXC622xXC                                   | read   | xx000xxx |

The registers available to the user on the MXC622xXC are summarized in the table above. Each register contains 8 bits.

#### \$00: XOUT - 8-bit x-axis acceleration output (read only)

| D7      | D6      | D5      | D4      | D3      | D2      | D1      | D0      |
|---------|---------|---------|---------|---------|---------|---------|---------|
| XOUT[7] | XOUT[6] | XOUT[5] | XOUT[4] | XOUT[3] | XOUT[2] | XOUT[1] | XOUT[0] |

8-bit x-axis acceleration output. Data in 2's complement format with range of -128 to +127.

### \$01: YOUT - 8-bit y-axis acceleration output (read only)

| D7      | D6      | D5      | D4      | D3      | D2      | D1      | D0      |
|---------|---------|---------|---------|---------|---------|---------|---------|
| YOUT[7] | YOUT[6] | YOUT[5] | YOUT[4] | YOUT[3] | YOUT[2] | YOUT[1] | YOUT[0] |

8-bit y-axis acceleration output. Data in 2's complement format with range of -128 to +127.

### \$02: STATUS - orientation and shake status register (read only)

| D7  | D6    | D5    | D4   | D3     | D2     | D1    | D0    |
|-----|-------|-------|------|--------|--------|-------|-------|
| INT | SH[1] | SH[0] | TILT | ORI[1] | ORI[0] | OR[1] | OR[0] |

OR[1:0] is a 2-bit indication of the device orientation, according to the following scheme: OR[1:0] = 01 - device is vertical in upright orientation; 00 - device is rotated 90 degrees clockwise; 11 - device is vertical in inverted orientation; 10 - device is rotated 90 degrees counterclockwise. The bits OR[1:0] are indicative of "long-term" orientation. The orientation is determined by measuring the signs of the quantities ax - ay, and ax + ay, as shown in Figure 12. In addition to these measurements, the orientation measurement must be validated by requiring that the larger in magnitude of ax, ay be greater than 3/8 g. In order for a new value of OR[1:0] to be written to the STATUS register, a valid measurement of the new orientation must be measured a consecutive number of times determined by the setting of bits ORC[1:0] in the DETECTION register. This provides a low-pass filtering and hysteresis effect that keeps a display from flickering near orientation boundaries

ORI[1:0] is the instantaneous device orientation. It follows the same scheme as OR[1:0], except that it is updated every time a valid orientation measurement is made, not subject to the same low-pass filtering as OR[1:0].

TILT is an indication of whether there is enough acceleration signal strength to make a valid orientation measurement. If TILT = 0, the orientation measurement is valid, if TILT = 1, then the orientation measurement is invalid. TILT is updated every measurement cycle.

SH[1:0] indicate whether a shake event has taken place, and if so, its direction. Shake can only be detected in a direction perpendicular

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If a shake is determined to have occurred, then the direction of the shake can be determined by the signs of the accelerations. The shake status is indicated as shown in the following table:

| SH[1] | SH[0] | Comment        |
|-------|-------|----------------|
| 0     | 0     | no shake event |
| 0     | 1     | shake left     |
| 1     | 0     | shake right    |
| 1     | 1     | undefined      |

INT is the interrupt bit. Setting this bit high will cause the INT pin to output a high level. The INT bit will be set whenever, 1. The orientation, as indicated by bits OR[1:0] changes, or 2. A shake event occurs. The microprocessor can then service the interrupt by reading the STATUS register. Once a shake event occurs, no new shake events will be recorded until the interrupt has been serviced, although the orientation bits will continue to be updated. The INT bit is cleared by a microprocessor read of the STATUS register.

#### \$04: DETECTION - orientation and shake detection parameters (write only)

| D7 | D6  | D5      | D4      | D3     | D2     | D1     | D0     |
|----|-----|---------|---------|--------|--------|--------|--------|
| PD | SHM | SHTH[1] | SHTH[0] | SHC[1] | SHC[0] | ORC[1] | ORC[0] |

PD = 1 powers down the MXC622xXC to a non-functional low power state with a maximum current drain of 1 uA.

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ORC[1:0] sets the orientation hysteresis time period, which is the time period of consecutive valid new instantaneous orientation measurements that must be made before a new orientation value is written into bits OR[1:0] in the STATUS register. The "long-term" orientation change is set by ORC[1:0] as follows: 00 - 160ms, 01 - 320ms, 10 - 640ms, 11 - 1280ms nominally.

SHC[1:0] sets the shake events time window, which determines the time window allowed between the first shake event (perpendicular acceleration exceeding the threshold set by SHTH[1:0]) and the second shake event (acceleration breaking the threshold with opposite sign, SHM = 0, or just reversing sign, SHM = 1). The time window is set by SHC[1:0] as follows: 00 - 80ms, 01 - 160ms, 10 - 320ms, 11 - 640ms nominally.

SHTH[1:0] sets the shake threshold that the perpendicular acceleration must exceed to trigger the first shake event. The settings for SHTH[1:0] are: 00 - 0.5 g, 01 - 1.0 g, 10 - 1.5 g, 11 - 2.0 g.

SHM is the shake mode bit. If SHM = 0, then for a shake to be detected, and written to SH[1:0] in the STATUS register, the second shake event must break the threshold set by SHTH[1:0] with the opposite sign of the first shake event, within the time window set by SHC[1:0]. If SHM = 1, then the second shake event must just have the opposite sign of the first shake event within the time window set by SHC[1:0].

MXC622xXC - Ultra Low Cost Accelerometer

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# MXC622xXC: Fully Integrated Thermal Accelerometer

### \$08 (6LSB),: CHIP\_ID - Chip ID of MXC622xXC (read only)

| D7    | D6    | D5    | D4    | D3    | D2    | D1    | D0    |
|-------|-------|-------|-------|-------|-------|-------|-------|
| ID[7] | ID[6] | ID[5] | ID[4] | ID[3] | ID[2] | ID[1] | ID[0] |
| X     | X     | 0     | 0     | 0     | X     | X     | Х     |

| Product   | xxx |  |
|-----------|-----|--|
| MXC6220XC | 000 |  |
| MXC6221XC | 001 |  |
| MXC6222XC | 010 |  |
| MXC6223XC | 011 |  |
| MXC6224XC | 100 |  |
| MxC6225XC | 101 |  |
| MXC6226XC | 110 |  |
| MXC6227XC | 111 |  |

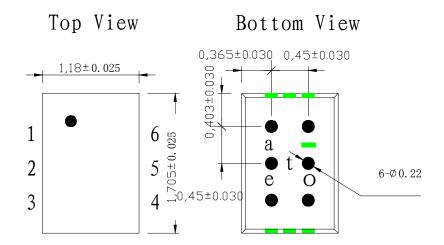
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## Package Drawing and Marking Illustration



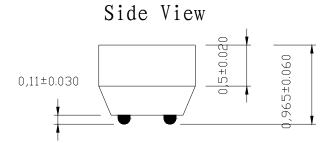


Figure 15

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